

# TPC8024-H

High-Efficiency DC/DC Converter Applications

Notebook PC Applications

Portable Equipment Applications

- Small footprint due to a small and thin package
- High-speed switching
- Small gate charge:  $Q_{SW} = 6.9 \text{ nC (typ.)}$
- Low drain-source ON-resistance:  $R_{DS(ON)} = 6.8 \text{ m}\Omega \text{ (typ.)}$
- High forward transfer admittance:  $|Y_{fs}| = 32 \text{ S (typ.)}$
- Low leakage current:  $I_{DSS} = 10 \text{ }\mu\text{A (max)}$  ( $V_{DS} = 30 \text{ V}$ )
- Enhancement mode:  $V_{th} = 1.1 \text{ to } 2.3 \text{ V}$  ( $V_{DS} = 10 \text{ V}$ ,  $I_D = 1 \text{ mA}$ )

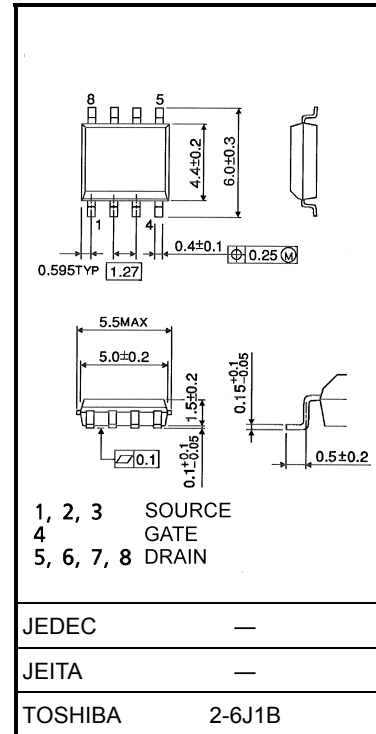
## Maximum Ratings ( $T_a = 25^\circ\text{C}$ )

Characteristic		Symbol	Rating	Unit
Drain-source voltage		$V_{DSS}$	30	V
Drain-gate voltage ( $R_{GS} = 20 \text{ k}\Omega$ )		$V_{DGR}$	30	V
Gate-source voltage		$V_{GSS}$	$\pm 20$	V
Drain current	DC (Note 1)	$I_D$	13	A
	Pulsed (Note 1)	$I_{DP}$	52	
Drain power dissipation ( $t = 10 \text{ s}$ ) (Note 2a)		$P_D$	1.9	W
Drain power dissipation ( $t = 10 \text{ s}$ ) (Note 2b)		$P_D$	1.0	W
Single-pulse avalanche energy (Note 3)		$E_{AS}$	110	mJ
Avalanche current		$I_{AR}$	13	A
Repetitive avalanche energy (Note 2a) (Note 4)		$E_{AR}$	0.084	mJ
Channel temperature		$T_{ch}$	150	$^\circ\text{C}$
Storage temperature range		$T_{stg}$	$-55 \text{ to } 150$	$^\circ\text{C}$

Note: For Notes 1 to 4, refer to the next page.

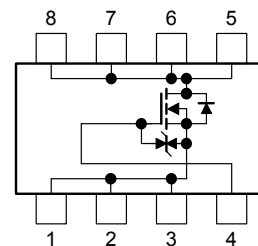
This transistor is an electrostatic-sensitive device. Handle with care.

Unit: mm



Weight: 0.085 g (typ.)

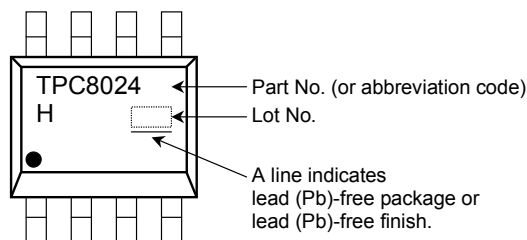
## Circuit Configuration



## Thermal Characteristics

Characteristic	Symbol	Max	Unit
Thermal resistance, channel to ambient (t = 10 s) (Note 2a)	$R_{th(ch-a)}$	65.8	°C/W
Thermal resistance, channel to ambient (t = 10 s) (Note 2b)	$R_{th(ch-a)}$	125	°C/W

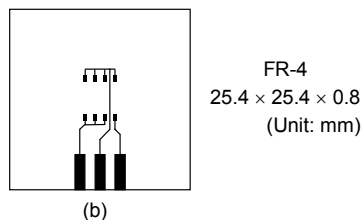
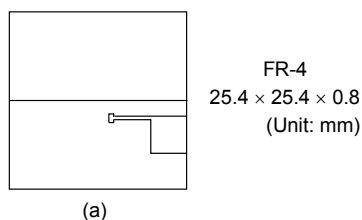
## Marking (Note 5)



Note 1: The channel temperature should not exceed 150°C during use.

Note 2: (a) Device mounted on a glass-epoxy board (a)

(b) Device mounted on a glass-epoxy board (b)

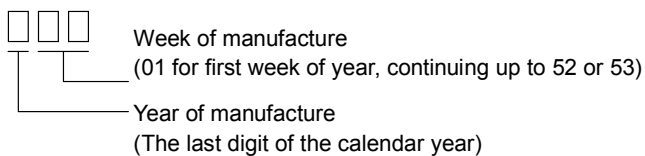


Note 3:  $V_{DD} = 24\text{ V}$ ,  $T_{ch} = 25^\circ\text{C}$  (initial),  $L = 0.5\text{ mH}$ ,  $R_G = 25\ \Omega$ ,  $I_{AR} = 13\text{ A}$

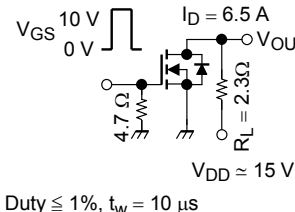
Note 4: Repetitive rating: pulse width limited by max channel temperature

Note 5: • on the lower left of the marking indicates Pin 1.

\* Weekly code: (Three digits)

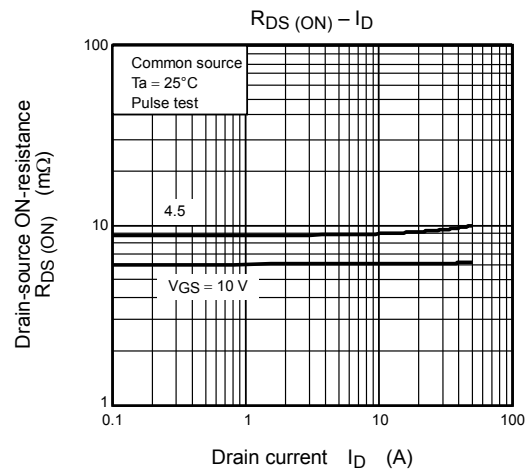
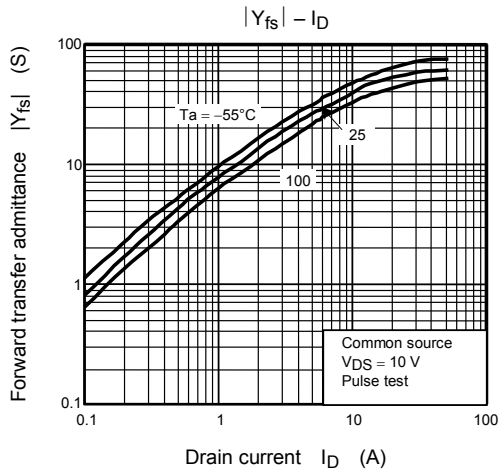
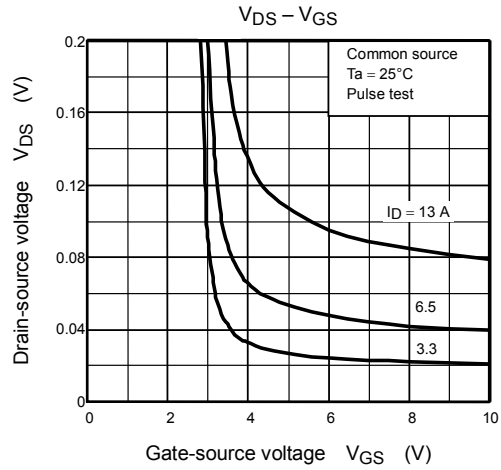
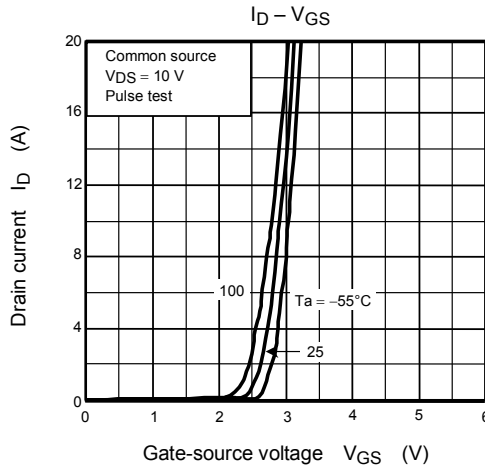
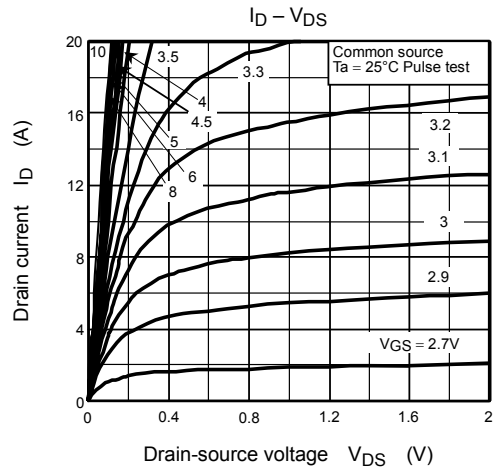
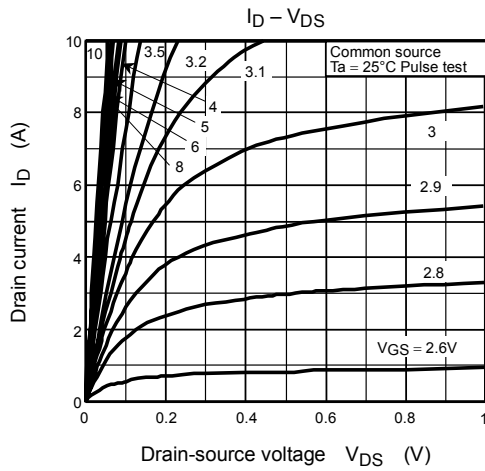


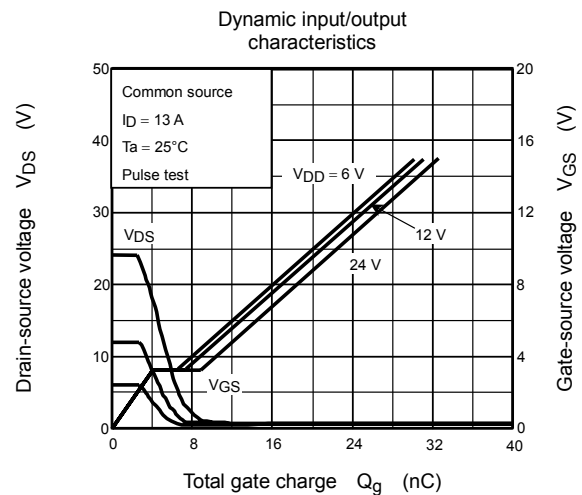
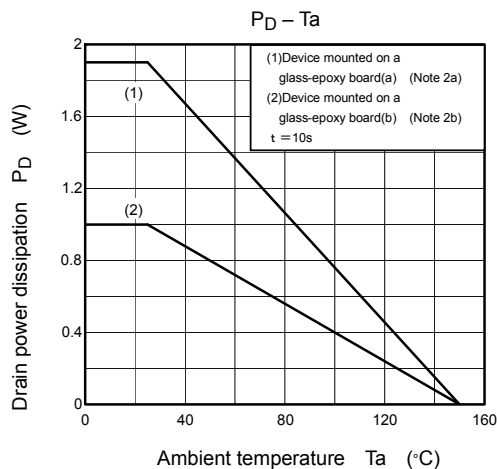
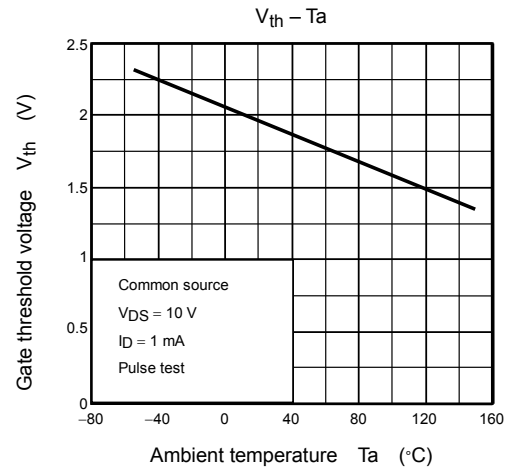
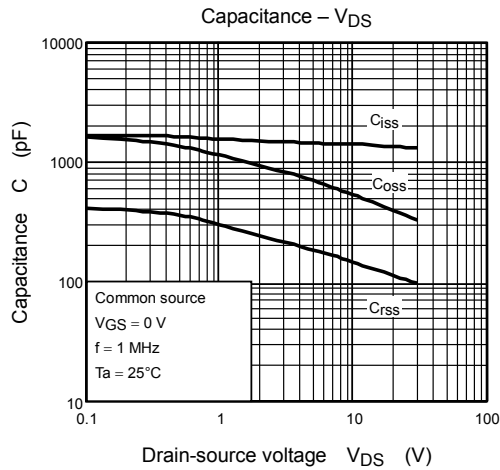
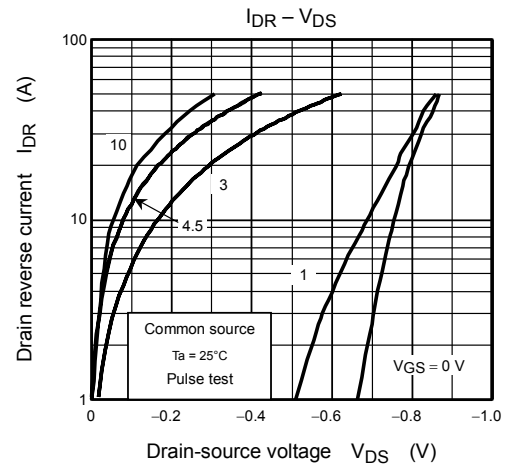
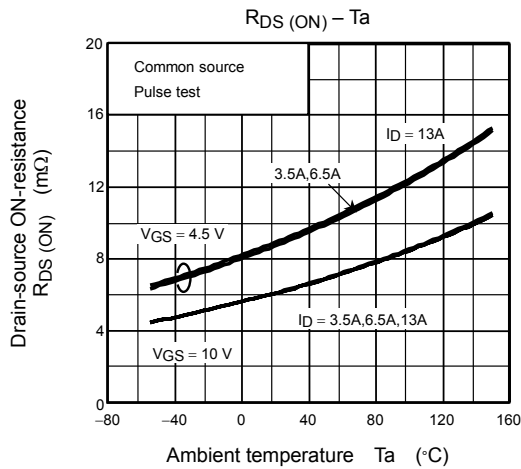
## Electrical Characteristics (Ta = 25°C)

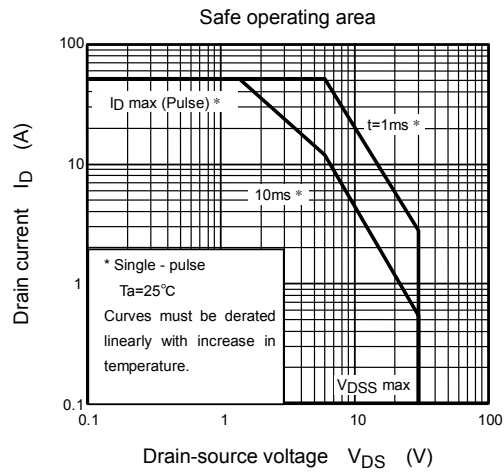
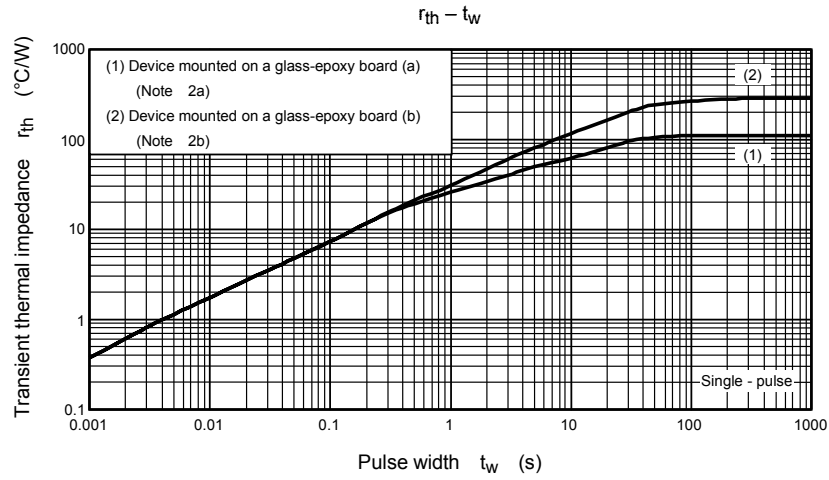
Characteristic		Symbol	Test Condition	Min	Typ.	Max	Unit
Gate leakage current		$I_{GSS}$	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0 \text{ V}$	—	—	$\pm 10$	$\mu\text{A}$
Drain cutoff current		$I_{DSS}$	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$	—	—	10	$\mu\text{A}$
Drain-source breakdown voltage	$V_{(BR)DSS}$	$I_D = 10 \text{ mA}, V_{GS} = 0 \text{ V}$	30	—	—	V	
	$V_{(BR)DSX}$	$I_D = 10 \text{ mA}, V_{GS} = -20 \text{ V}$	15	—	—		
Gate threshold voltage		$V_{th}$	$V_{DS} = 10 \text{ V}, I_D = 1 \text{ mA}$	1.1	—	2.3	V
Drain-source ON-resistance		$R_{DS(ON)}$	$V_{GS} = 4.5 \text{ V}, I_D = 6.5 \text{ A}$	—	9.5	13	$\text{m}\Omega$
			$V_{GS} = 10 \text{ V}, I_D = 6.5 \text{ A}$	—	6.8	9	
Forward transfer admittance		$ Y_{fs} $	$V_{DS} = 10 \text{ V}, I_D = 6.5 \text{ A}$	16	32	—	S
Input capacitance		$C_{iss}$	$V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	—	1395	—	pF
Reverse transfer capacitance		$C_{rss}$		—	140	—	
Output capacitance		$C_{oss}$		—	525	—	
Switching time	Rise time	$t_r$	 <p><math>V_{GS} = 10 \text{ V}, 0 \text{ V}</math> <math>I_D = 6.5 \text{ A}</math> <math>R_L = 2.3 \Omega</math> <math>V_{DD} \approx 15 \text{ V}</math> Duty <math>\leq 1\%</math>, <math>t_w = 10 \mu\text{s}</math></p>	—	5	—	ns
	Turn-on time	$t_{on}$		—	11	—	
	Fall time	$t_f$		—	10	—	
	Turn-off time	$t_{off}$		—	31	—	
Total gate charge (gate-source plus gate-drain)		$Q_g$	$V_{DD} \approx 24 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 13 \text{ A}$	—	23	—	nC
			$V_{DD} \approx 24 \text{ V}, V_{GS} = 5 \text{ V}, I_D = 13 \text{ A}$	—	13	—	
Gate-source charge 1		$Q_{gs1}$	$V_{DD} \approx 24 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 13 \text{ A}$	—	4.5	—	
Gate-drain ("Miller") charge		$Q_{gd}$		—	4.9	—	
Gate switch charge		$Q_{SW}$		—	6.9	—	

## Source-Drain Ratings and Characteristics (Ta = 25°C)

Characteristic		Symbol	Test Condition	Min	Typ.	Max	Unit
Drain reverse current	Pulse (Note 1)	$I_{DRP}$	—	—	—	52	A
Forward voltage (diode)		$V_{DSF}$	$I_{DR} = 13 \text{ A}, V_{GS} = 0 \text{ V}$	—	—	-1.2	V







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